

#### • General Description

The AGM1099EL combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{\text{DS(ON)}}$ .

This device is ideal for load switch and battery protection applications.

#### Features

- Advance high cell density Trench technology
- Low R<sub>DS(ON)</sub> to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

#### Application

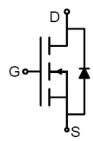
- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

# **Product Summary**

BVDSS	RDSON	ID
100V	100mΩ	5.0A

#### **SOT-23 Pin Configuration**





#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package Reel Size		Tape width	Quantity	
1099EL	AGM1099EL	SOT-23			3000	

#### Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	5.0	А
.5	Drain Current-Continuous(Tc=100℃)	3.2	А
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 2)	16	А
PD	Maximum Power Dissipation(Tc=25℃)	3.1	W
	Maximum Power Dissipation(Tc=100℃)	1.25	W
EAS	Avalanche energy (Note 3)		mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	erating Junction and Storage Temperature Range -55 To 150	

#### Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>		40	°C/W
R0JC	Thermal Resistance Junction-Case <sup>1</sup>			°C/W



Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Tvn	Max	Unit
		Conditions	IVIIII	Тур	IVIAX	Offic
On/Off St	ates T					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250µA	100			V
IDSS	Zero Gate Voltage Drain Current	VDS=100V,VGS=0V			1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250µA	1.3	1.8	2.4	V
gFS	Forward Transconductance	VDS=10V,ID=5A				S
<b>5</b> / .		VGS=10V, ID=4A		100	120	mΩ
RDS(on)	Drain-Source On-State Resistance	VGS=4.5V, ID=3A		120	145	mΩ
Dynamic	Characteristics					
Ciss	Input Capacitance	VDS=50V,VGS=0V,		182		pF
Coss	Output Capacitance	F=1MHZ		30		pF
Crss	Reverse Transfer Capacitance			3.6		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		2.5		Ω
Switching	Times					
td(on)	Turn-on Delay Time			11		nS
tr	Turn-on Rise Time	VGS=10V,VDS=50V,		6.0		nS
td(off)	Turn-Off Delay Time	ID=5A,RGEN=5Ω		30		nS
tf	Turn-Off Fall Time			4.0		nS
Qg	Total Gate Charge			3.57		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=50V, ID=5A		0.76		nC
Qgd	Gate-Drain Charge			0.71		nC
Source-D	rain Diode Characteristics					
ISD	Source-Drain Current(Body Diode)				5.0	А
VSD	Forward on Voltage	VGS=0V,IS=5A			1.2	V
trr	Reverse Recovery Time	IF=5A , dI/dt=100A/μs ,		50		ns
Qrr	Reverse Recovery Charge	TJ=25℃		102		nc

Notes 1. The maximum current rating is package limited.

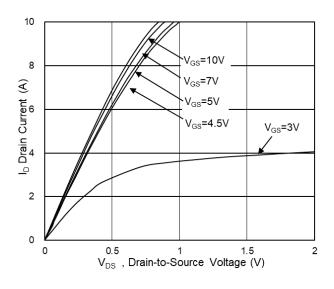
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25℃

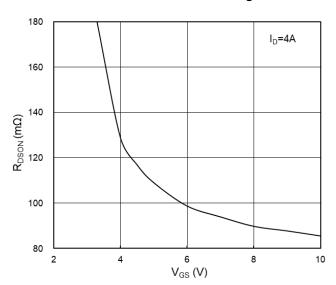


# **Characteristics Curve:**

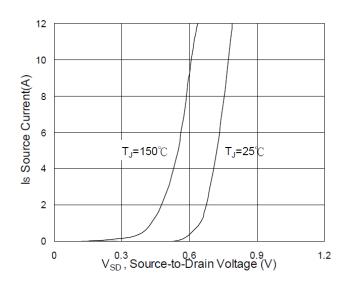
Typ. Output Characteristics



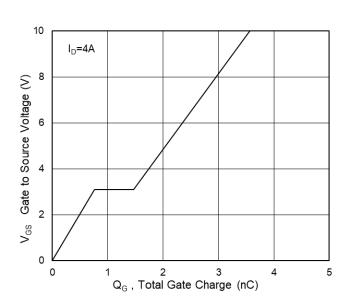
On-Resistance vs G-S Voltage



## **Source Drain Forward Characteristics**

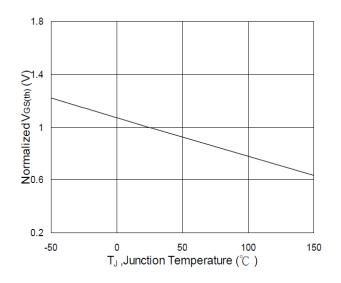


## **Gate-Charge Characteristics**

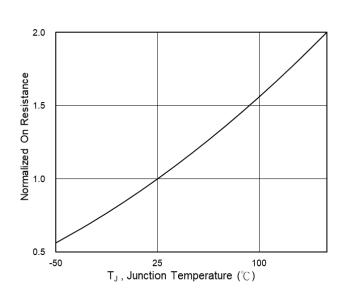




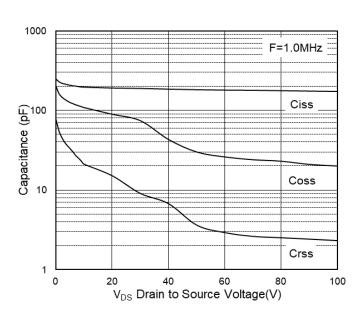
# Normalized $V_{GS(th)}$ vs $T_J$



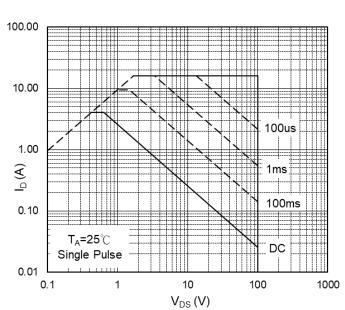
# Normalized $R_{\text{DSON}}$ vs $T_{\text{J}}$



#### Capacitance

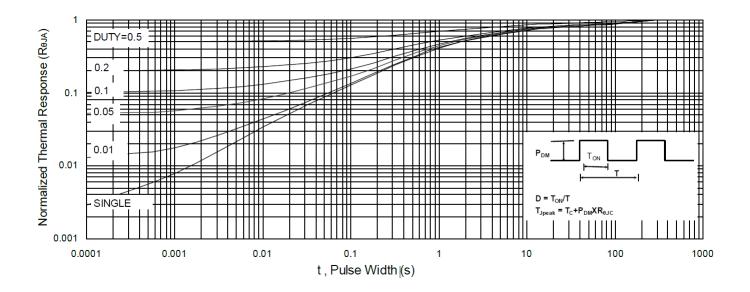


## **Safe Operating Area**



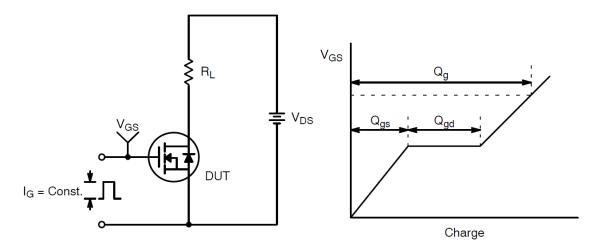


# Max. transient thermal impedance

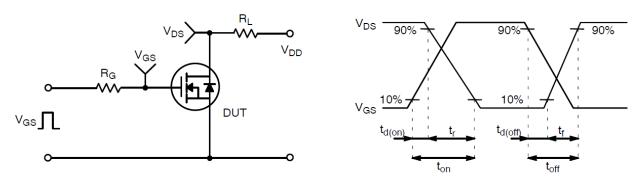




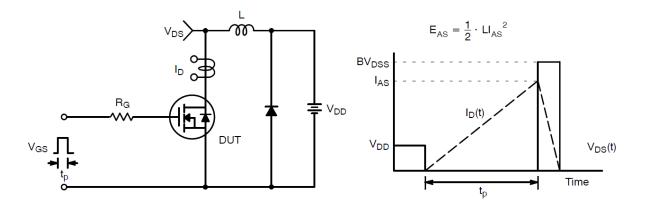
## **Test Circuit and Waveform:**



**Gate Charge Test Circuit & Waveform** 



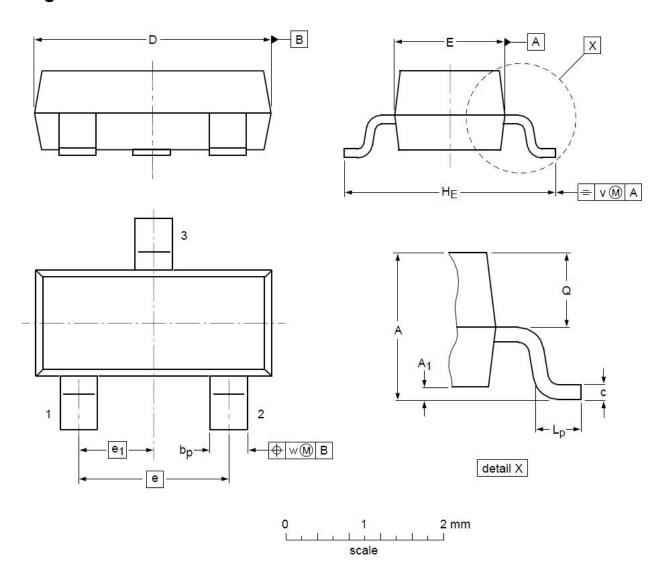
**Resistive Switching Test Circuit & Waveforms** 



**Unclamped Inductive Switching Test Circuit & Waveforms** 



# Package Mechanical Data-SOT-23



# **DIMENSIONS** ( unit : mm )

Symbol	Min	Тур	Max	Symbol	Min	Тур	Max
Α	0.90	1.01	1.15	<b>A</b> <sub>1</sub>	0.01	0.05	0.10
b <sub>p</sub>	0.30	0.42	0.50	С	0.08	0.13	0.15
D	2.80	2.92	3.00	E	1.20	1.33	1.40
е		1.90		<b>e</b> 1		0.95	
HE	2.25	2.40	2.55	Lp	0.30	0.42	0.50
Q	0.45	0.49	0.55	v		0.20	
w		0.10					



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